

MS 200 Manual Hot Melt Bead Applicator



Technical Data for MS 200

The MS 200 works with 43 mm stick, granulate, chip or wafer formed hot melt adhesives, with no compressed air required.

The mechanical thermostat temperature control is set to the required level by a simple adjustment on the side of the applicator. You can adjust the temperature from 60 °C to 200 °C to suit the specific adhesive being used.

The integrated magnetic foot allows the handgun to stand upright on any magnetic surface. A wire stand provides a secure stand on non-magnetic surfaces. Ergonomic shape, large fill port, left or right hand use, provides comfortable use without operator fatigue.

Various nozzles styles are available, a tool balancer, as well as pre-melting units to meet individual requirements and applications.

NOTE: All specifications are adhesive dependent

Voltage	115V, 600W
No Air Required	
Temperature Control	Thermostat
Overheat protection	Thermal
Heat-up time, approx.	5 minutes
Tank capacity/l	250 grams
Extrusion rate, max. per minute	100 g/min
Electrical cord length	2 meters
Weight of handgun	1220 grams

Adhesive Application Specialists